

# CM1408-04DE

## 4-Channel LCD and Camera EMI Filter Array with ESD Protection

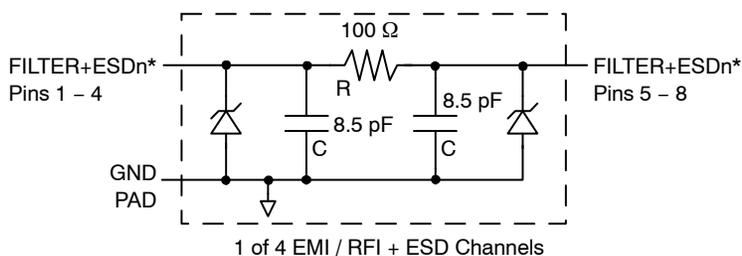
### Features

- Four Channels of EMI Filtering with Integrated ESD Protection
- Pi-Style EMI Filters in a Capacitor-Resistor-Capacitor (C-R-C) Network
- $\pm 15$  kV ESD Protection on Each Channel (IEC 61000-4-2 Level 4, Contact Discharge)
- $\pm 30$  kV ESD Protection on Each Channel (HBM)
- Greater than  $-35$  dB Attenuation (Typical) at 1 GHz
- WDFN Packaging with 0.5 mm Lead Pitch:
  - 8-Lead WDFN, 2.0 mm x 2.0 mm
- Increased Robustness Against Vertical Impacts During Manufacturing Process
- These Devices are Pb-Free and are RoHS Compliant

### Applications

- LCD and Camera Data Lines in Mobile Handsets
- I/O Port Protection for Mobile Handsets, Notebook Computers, PDAs, etc.
- EMI Filtering for Data Ports in Cell Phones, PDAs or Notebook Computers
- Wireless Handsets
- Handheld PCs/PDAs
- LCD and Camera Modules

### BLOCK DIAGRAM



\*See Package/Pinout Diagrams for expanded pin information.



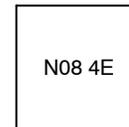
ON Semiconductor®

<http://onsemi.com>



1  
WDFN8  
DE SUFFIX  
CASE 511BE

### MARKING DIAGRAM



N08 4E = CM1408-04DE

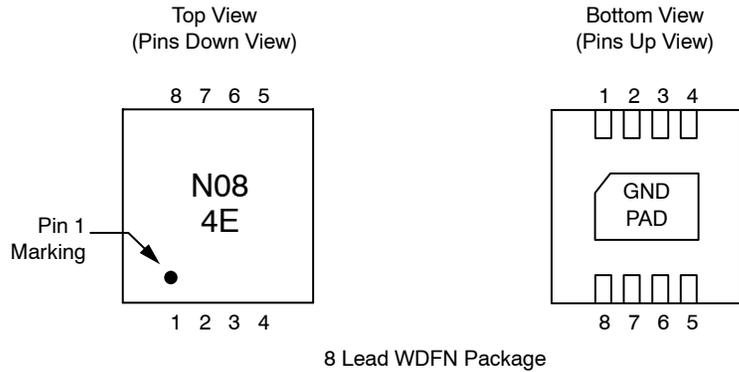
### ORDERING INFORMATION

Device	Package	Shipping†
CM1408-04DE	WDFN-8 (Pb-Free)	3000/Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

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## PACKAGE / PINOUT DIAGRAMS



**Table 1. PIN DESCRIPTIONS**

Device Pin(s)	Name	Description	Device Pin(s)	Name	Description
1	FILTER1	Filter + ESD Channel 1	8	FILTER1	Filter + ESD Channel 1
2	FILTER2	Filter + ESD Channel 2	7	FILTER2	Filter + ESD Channel 2
3	FILTER3	Filter + ESD Channel 3	6	FILTER3	Filter + ESD Channel 3
4	FILTER4	Filter + ESD Channel 4	5	FILTER4	Filter + ESD Channel 4
GND PAD	GND	Device Ground			

## SPECIFICATIONS

**Table 2. ABSOLUTE MAXIMUM RATINGS**

Parameter	Rating	Units
Storage Temperature Range	-65 to +150	°C
DC Power per Resistor	100	mW
DC Package Power Rating	500	mW

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

**Table 3. STANDARD OPERATING CONDITIONS**

Parameter	Rating	Units
Operating Temperature Range	-40 to +85	°C

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**Table 4. ELECTRICAL OPERATING CHARACTERISTICS** (Note 1)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
R	Resistance		80	100	120	$\Omega$
C <sub>TOTAL</sub>	Total Channel Capacitance	At 2.5 VDC Reverse Bias, 1 MHz, 30 mVAC	14	17	22	pF
C	Capacitance C	At 2.5 VDC Reverse Bias, 1 MHz, 30 mVAC		8.5		pF
V <sub>DIODE</sub>	Standoff Voltage	I <sub>DIODE</sub> = 10 $\mu$ A		6.0		V
I <sub>LEAK</sub>	Diode Leakage Current (reverse bias)	V <sub>DIODE</sub> = 3.3 V		0.1	1.0	$\mu$ A
V <sub>SIG</sub>	Signal Clamp Voltage Positive Clamp Negative Clamp	I <sub>LOAD</sub> = 10 mA I <sub>LOAD</sub> = -10 mA	5.6 -1.5	6.8 -0.8	9.0 -0.4	V
V <sub>ESD</sub>	In-system ESD Withstand Voltage a) Human Body Model, MIL-STD-883, Method 3015 b) Contact Discharge per IEC 61000-4-2 Level 4	(Notes 2 and 3)	30 15			kV
R <sub>DYN</sub>	Dynamic Resistance Positive Negative			2.3 0.9		$\Omega$
f <sub>C</sub>	Cut-off Frequency Z <sub>SOURCE</sub> = 50 $\Omega$ , Z <sub>LOAD</sub> = 50 $\Omega$	Channel R = 100 $\Omega$ , Channel C <sub>SINGLE</sub> = 8.5 pF		200		MHz

1. T<sub>A</sub> = 25°C unless otherwise specified.
2. ESD applied to input and output pins with respect to GND, one at a time.
3. These parameters are guaranteed by design and characterization.

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## PERFORMANCE INFORMATION

Typical Filter Performance ( $T_A = 25^\circ\text{C}$ , DC Bias = 0 V, 50  $\Omega$  Environment)

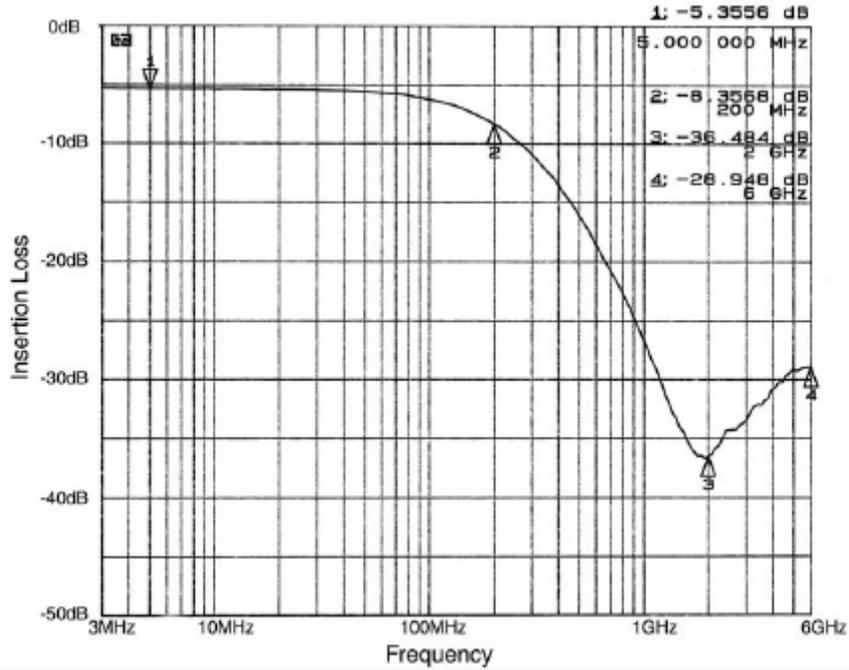


Figure 1. Insertion Loss vs. Frequency (FILTER1 Input to GND)

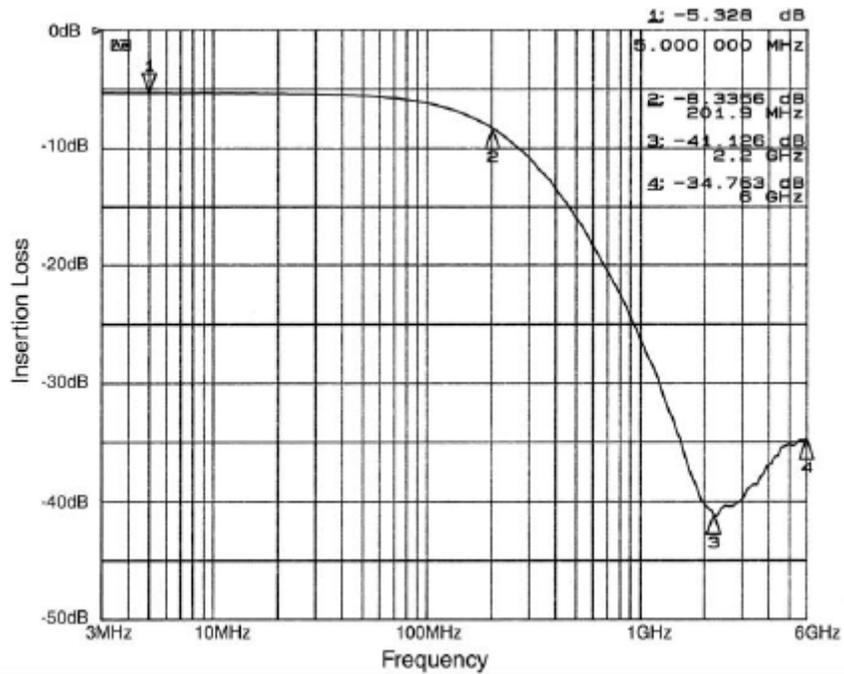


Figure 2. Insertion Loss vs. Frequency (FILTER2 Input to GND)

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## PERFORMANCE INFORMATION (Cont'd)

Typical Filter Performance ( $T_A = 25^\circ\text{C}$ , DC Bias = 0 V,  $50\ \Omega$  Environment)

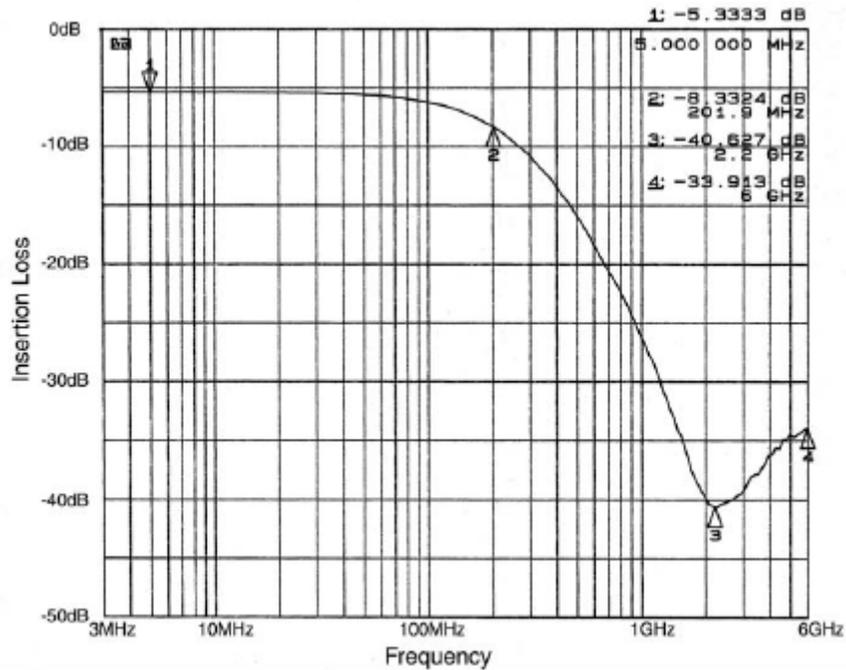


Figure 3. Insertion Loss vs. Frequency (FILTER3 Input to GND)

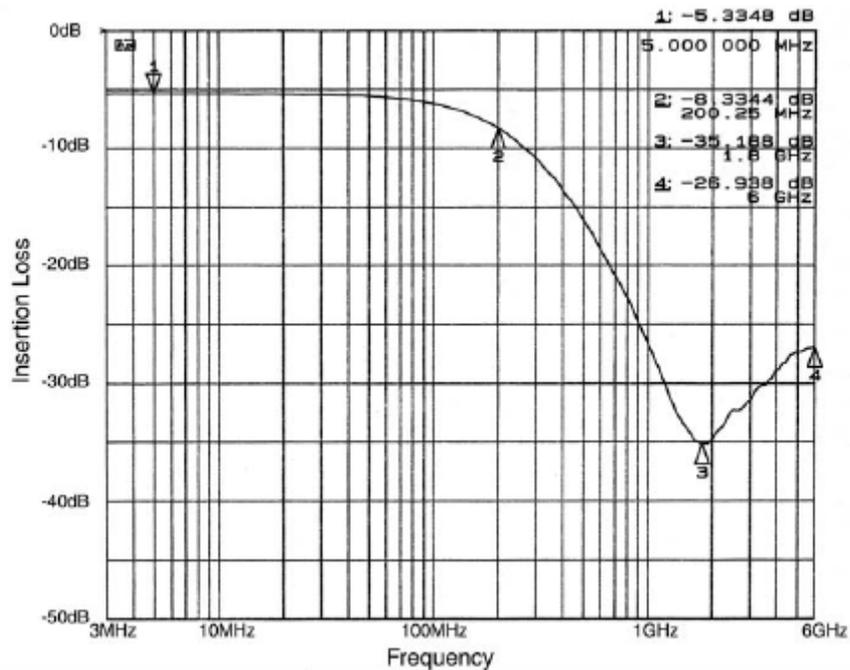


Figure 4. Insertion Loss vs. Frequency (FILTER4 Input to GND)

PERFORMANCE INFORMATION (Cont'd)

Typical Diode Capacitance vs. Input Voltage

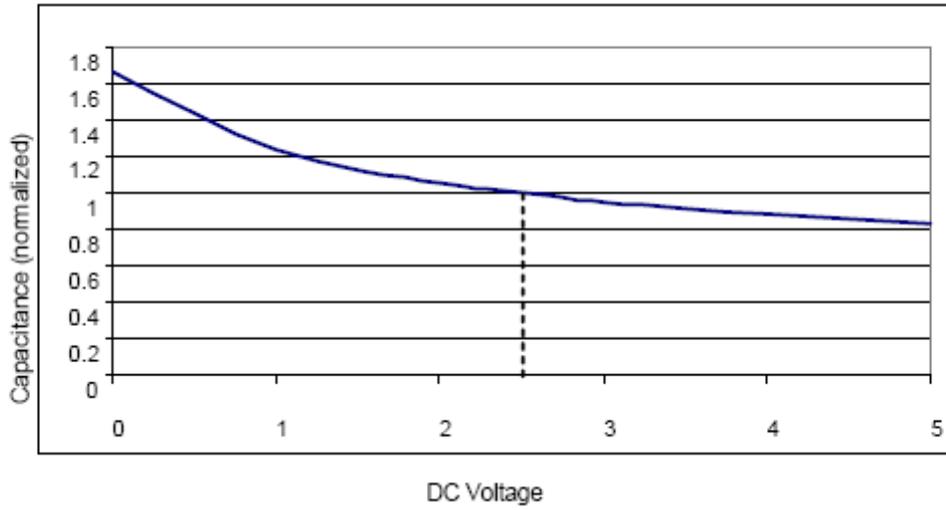
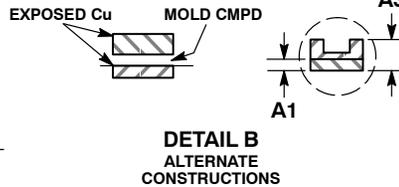
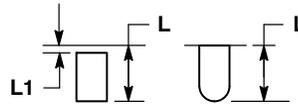
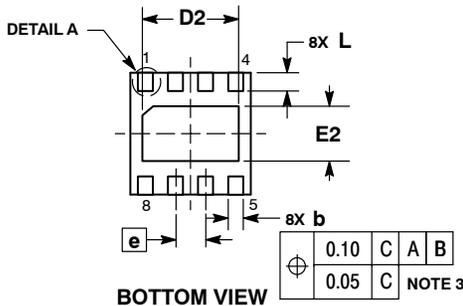
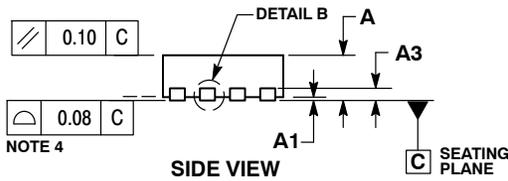
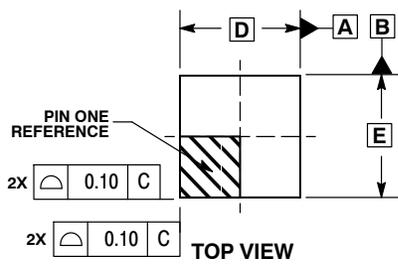


Figure 5. Filter Capacitance vs. Input Voltage  
(normalized to capacitance at 2.5 VDC and 25°C)

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## PACKAGE DIMENSIONS

WDFN8 2x2, 0.5P  
CASE 511BE-01  
ISSUE O

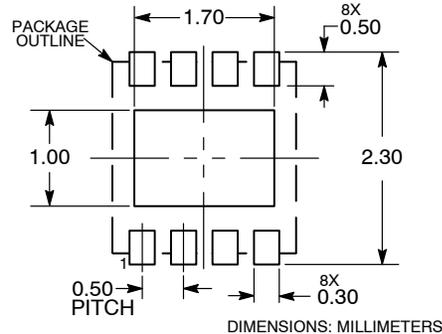


**NOTES:**

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.30 MM FROM TERMINAL TIP.
4. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.

DIM	MILLIMETERS	
	MIN	MAX
A	0.70	0.80
A1	0.00	0.05
A3	0.20	REF
b	0.20	0.30
D	2.00	BSC
D2	1.50	1.70
E	2.00	BSC
E2	0.80	1.00
e	0.50	BSC
K	0.25	REF
L	0.20	0.40
L1	---	0.15

**RECOMMENDED  
SOLDERING FOOTPRINT\***



\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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